NIBS2022 (3-7 Oct. 2022), oral presentation, Tuesday 4 October 2022, Padova, Italy Fluid models of radiofrequency coupling and plasma density for ion sources as NIO1 nibs22*



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1) Introduction: inductive plasma heating 2) The rf conductivity in bounded plasmas (and the skin depth) 3) Non-magnetized plasmas 4) Magnetized plasmas and model 5) Simulations workflow, and results for magnetized plasma 6) Conclusions

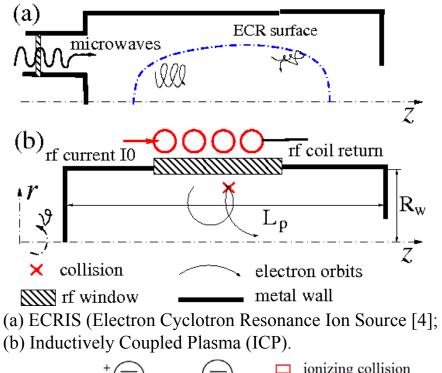
1) Introduction

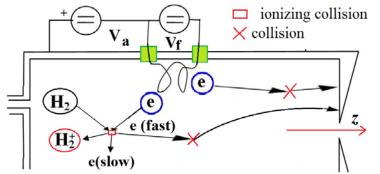
Ionized gases, also known as plasmas, need a continuos influx of energy, also known as heating, to maintain ionization. Heating methods: (a) microwave and (b) radiofrequency (not dissimilar from microwave food cooking); (c) arc. Microwaves/rf are often preferred in plasmas for ion production [...]

the plasma angular frequency $\omega_p = \sqrt{n_e e^2/(m_e \epsilon_0)}$ depends on electron density n_e

When n_e equals to the cutoff density n_c $n_c = m_e \varepsilon_0 \omega^2 / e^2$

where ω is the angular microwave frequency, we have $\omega = \omega_{\mathcal{D}}$



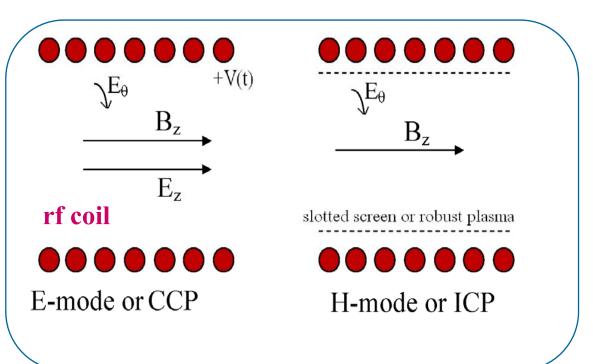


(c) arc: a <u>known</u> current of e- fast ionizes (red dots) gas, giving H_2^+ and (cold) e

Typically $n_e = 10^{18} \text{ m}^{-3}$ in ion source center, so microwave source (ECRIS [4]) are below cut off density and radiofrequency plasma (b) have density over the cutoff

The plasma can couple to rf coil in two modes

1) Capacitive Coupled Plasma (E-Mode : very low electron density, the axial electric field Ez [13] directly accelerates them, and deconfines them (that, Ez pushes them out of the plasma)



2) Inductive Coupled Plasma (H-mode, dense plasma); axial electric field E_z is suppressed (by a slotted screen or by plasma polarization); the weaker E_9 accelerates electrons in multisteps, by stochastic or collision phase mixing, and electron energy distribution is broad (similar to a Maxwellian one). We restrict to this coupling.

2) RADIOFREQUENCY (rf) HEATING

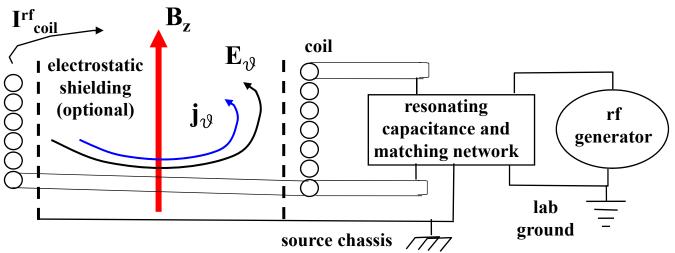
a) The simpler model: assuming that plasma behaves as the secondary of a transformer; this model may overestimate efficiencies

There are rf losses in the coil and the metal wall of the vacuum chamber, and in the Faraday shield when used

b) A next simpler model

Assuming conductivity σ is known in plasmas (see later), rf heating is a typical 'lossy dielectric problem' (analogy: cooking; rf ovens for ion sources; cold crubibles) Plasma (or a screen) shields electric potential, so that only azimuthal part of vector potential remains:

$$\mathbf{A} \cong \Re \, \hat{\vartheta} A_{\vartheta}(r,z) \mathrm{e}^{\mathrm{i}\omega t} \qquad \phi \cong 0 \qquad \Re \text{ (real part of)} \\ \text{is usually understood} \\ \text{Maxwell} \Rightarrow \quad r A_{\vartheta,zz} + (r A_{\vartheta,r})_{,r} + r Q A_{\vartheta} = \mu_0 \sigma U_k \qquad (2a) \\ \text{where } U_k \text{ is applied voltage/radians, a comma means 'partial differentiation' and Q depends on material} \\ Q = -r^{-2} - \mathrm{i}\mu_0 \omega \sigma + \varepsilon_r (\omega/c)^2 \qquad (2b) \end{cases}$$



2.2) The conductivity in plasma (mainly due to electrons)

In plasma, rf field strength is not uniform (typically it is decaying, that is the skin effect), and rf includes both magneyic and electric field so electron motion is very complicate, as easily seen in oneparticle simulations, also

for weak plasma (electron density n_e to zero)

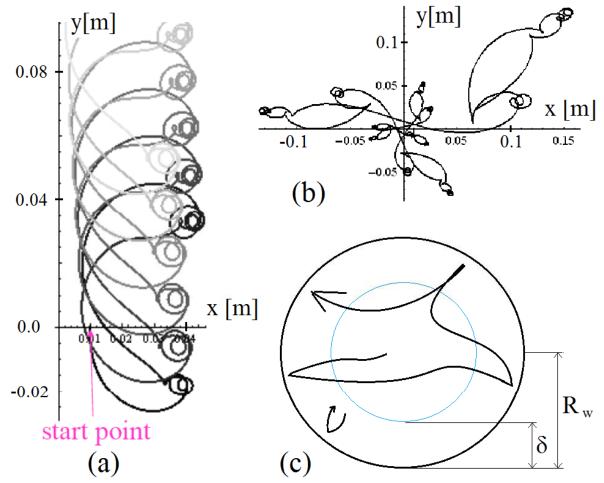


Figure: samples of electron orbits in rf fields in (a) weak plasma, uniform B_z and E_z (b) weak plasma, uniform B_z and $E_{\vartheta} \propto r$ (c) strong plasma, ie skin depth δ smaller then radius R_w

2.3) the local conductivity σ model and the skin depth

Strictly speaking conductivity is nonlocal operator (defined by a functional derivative) $\sigma = \check{\delta}\mathbf{j}/\check{\delta}\mathbf{E}$

A local expression including only gas collision friction or 'collision equivalenced' effect is $\sigma = n_e e^2/(v_c + i\omega)$ with $v_c = v_m + v_s$

 V_m collision frequency due to real collision with gas or ions V_s stochastic term to fit anything else (see section 2.4), like
collisions with walls or oscillation larger than skin depthThe material function Q is then simply

$$Q = \varepsilon_r \frac{\omega^2}{c^2} - \frac{1}{r^2} - \frac{\omega_p^2}{c^2} \frac{\mathrm{i}\omega}{v_c + \mathrm{i}\omega}$$

In induction plasma $\omega_p \gg \omega, v_c$ skin depth δ approximates as

$$rac{\delta}{c} \simeq rac{\sqrt{2(1+\sqrt[p]{2})}}{\sqrt{1+\sqrt{1+\sqrt[p]{2}}}} rac{1}{\omega_s} \qquad \qquad \chi = v_c/\omega \qquad \qquad \omega_s^2 = \omega_p^2 - \omega^2$$

3) Non-magnetized plasma: formulas for effective collision frequency Let us recall that, in some simple case [6] as electron bouncing from a plasma/wall sheath, power absorbption can be calculated from kinwtic and nonlocal model. $\frac{P_w}{dt} = n^w \frac{e^2 \delta^2}{2} I_1(\alpha) \qquad \alpha = \frac{4\omega^2 \delta^2}{2}$

with thermal velocity

$$\frac{T_w}{|E_w|^2} = n_e^w \frac{c \cdot \sigma}{m_e v_{th}} I_1(\alpha) \quad , \quad \alpha = \frac{\pi \sigma}{\pi v_h^2}$$
$$v_{th} = (8T_e/\pi m_e)^{1/2}$$
$$I_1(\alpha) = [(1+\alpha)e^{\alpha}\Gamma(0,\alpha) - 1]/\pi$$

[The time electron spend inside rf skin layer is $\tau = 2 \delta/v_{th}$, so $\omega \tau$ is a dimensionless parameter, as well α is]

The effective coll. frequency is defined such as to obatain the same power absotion which gives

$$\frac{\cancel{p}}{1+\cancel{p}^2} \cong 2\sqrt{\pi\alpha}I_1(\alpha)$$

This has two solution for v, shown v^+ or v^- in the figure. Also compare [Jain,2018]

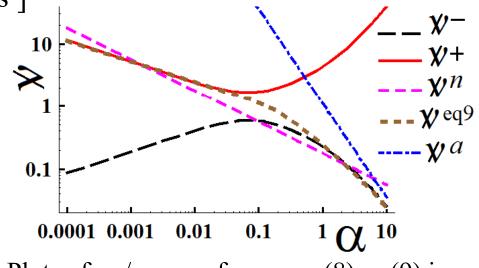


Figure: Plots of $v_c/\omega \text{ vs } \alpha$, from eqs. (8) or (9) in [Cavenago, GASS 2020 (virtual, IEEExplore)]

4) Magnetized plasmas and plasma model We have

 $B_z = B_f \sin(\omega t) + B_s$, $E_{\vartheta} = \frac{1}{2}\omega r B_f \cos(\omega t)$ with static magnetic fields B_s , which gives the well known cyclotron frequency $\Omega_s = e B_s/m_e$, and rf magnetic field with amplitude B_f , and similarly $\Omega_f = e B_f/m_e$. We can combined both as

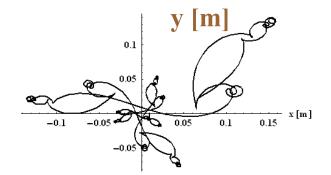
$$\Omega_t^2 = rac{1}{2}\Omega_f^2 + \Omega_s^2$$

Generalizing ref [Tuszewski, 1997 Phys. Plasmas] formula, for $\omega \ll v_c < \Omega_t$ the conductivity is about

$$\langle \sigma \rangle = \frac{n_e e^2}{m_e \sqrt{\nu_c^2 + \Omega_t^2}} \left(1 - \frac{i\omega\nu_c}{\nu_c^2 + \Omega_t^2} + O(\nu_c^2) \right)$$

2D MODEL The static magnetic field is azimuth averaged as $B^s = \left[\int d\vartheta |\mathbf{B}^s|^2/(2\pi)\right]^{1/2}$ $e + H_2(X) \rightarrow e + e + H_2^+(X')$ $e + H^0(X) \rightarrow e + e + H^+(X')$

TOTAL IONIZATION RATE $n_g n_e K_{iz}(T_e) = n_{iz}$



Motion of e- with $B_f=5$ G and $B_s = -2$ G

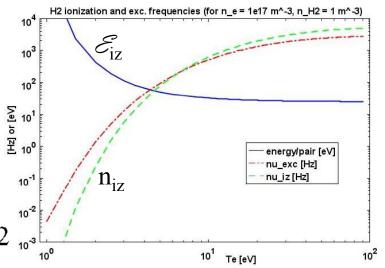


Figure: \mathcal{E}_{c} , the energy lost per pair (e ion+) produced vs the plasma electron temperature T_{e} ; note its peak for T_{e} <3 eV. Reason is that excitation rate is there much greater than ionization rate, as shown

Plasma heat diffusion balances with electromagnetic heat P_h and energy loss in ionization

$$-\nabla(K_e \nabla T_e) = P_h - n_e n_g K_{iz} \mathscr{E}_{iz}$$
$$P_h = \frac{1}{2} \Re(j_{\vartheta}^* E_{\vartheta}) \qquad u_B = \sqrt{T_e/M_i} \qquad K_e = \frac{3n_e T_e \nu_m}{2m(\nu_m^2 + \Omega_s^2 + \Omega_f^2)^{1/2}}$$

where K_e is thermal conducitivity, u_B the Bohm speed, $K_{iz}(T_e)$ is the ionization costant (see graph for n_{iz}) and \mathcal{E}_{iz} is the energy loss per ionization pair (see graph)

Ions accelrated by sheaths before they hit wall where their energy is wasted. Since typical sheath are localized and requires a thin mesh for PDE solution, we exclude them from PDE solution domain, including known sheath effect in boundary conditions:

$$-K_e \mathbf{n} \cdot \nabla T_e = u_B n_e \phi_d$$

(with **n** the outward normal vector), that is the heat flow at wall equals the energy lost by ions

$$\phi_d = \frac{1}{2} T_e \ln[M/2\pi m]$$

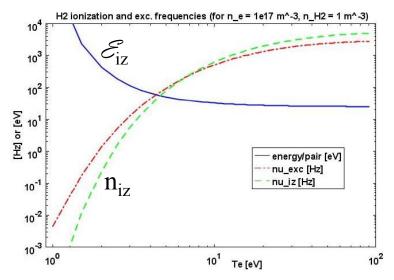


Figure: \mathcal{E}_c , the energy lost per pair (e ion+) produced vs the plasma electron temperature T_e ; note its peak for $T_e < 3$ eV. Reason is that excitation rate is there much greater than ionization rate, as shown

MODEL We require quasi neutrality $n_e + n_H^- = n_i$

that is $n_e = n_i$ (positive ion) almost everywhere (since we get H- only near extraction) and that flow of electrons Γ_{e} originates from ionization rate n_{iz} as the flow of ions Γ_i does $\operatorname{div} \mathbf{\Gamma}_i = \operatorname{div} \mathbf{\Gamma}_e = n_{\varrho} n_e K_{iz}(T_e) = n_{iz}$

DIFFUSION The slower charges (ions typically) drag the opposite charges, so

$$\Gamma_i = -D_a \operatorname{grad}\left(n_e + s_p \frac{B_f^2}{4\mu_0 T_e}\right)$$
 or simply $\Gamma_i = -D_a \operatorname{grad} n_e$

neglecting the ponderomotive B^{f} effects ($s_{p}=0$), with D_{a} the ambipolar diffusion coefficient. Let the ambipolar diffusion velocity v_a and the ion thermal speed v_{th}^{i} be

 $\mathbf{v}_a = \mathbf{\Gamma}_i / n_e$ when \mathbf{v}_a much lower \mathbf{v}_{th}^i ; $D_a \cong T_e / M_i \mathbf{v}_i$ $v_{th}^i = \sqrt{T_i/M_i}$

otherwise, D_a is smoothly reduced so that $v_a \leq v_{th}^{i}$

BOUNDARIES Some secondary electron emission (SEE) from wall may help plasma (and in ECRIS source wall coating effect was well known; Drentje, 2003, Bentounes, 2018); so we call s_{ee} the fraction of e/ions (re)emitted from walls

$$-D_a \mathbf{n} \cdot \operatorname{grad} n_e \equiv \mathbf{n} \cdot \mathbf{\Gamma}_i = n_e (1 - s_{ee}) \sqrt{T_e/M_i}$$

5) Solution and results: 5.1 Work flow of a typical multiphysics simulation

There are two good reasons for iterative solving of previous model:

1) Some variable (as ne or Te) are real valued, some are complex (magnetic potential phasor), so ne and Te must be kept real against rounding error effects

2) The problem is nonlinear (it may have many solutions in principle), so the user has to give an adequate initial guess, which is easier for real variables alone

3) PDE are singular at ne =0 and Te=0, so we impose ne>0 and Te>0

As practical fact, computer RAM is limited (not a TB yet): so in our code solution is also performed in 2D with preliminary averaging of the static magnetic field (which has a 3D structure, with strong multipoles).

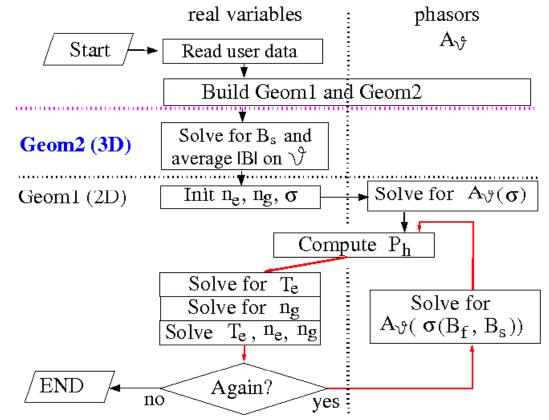


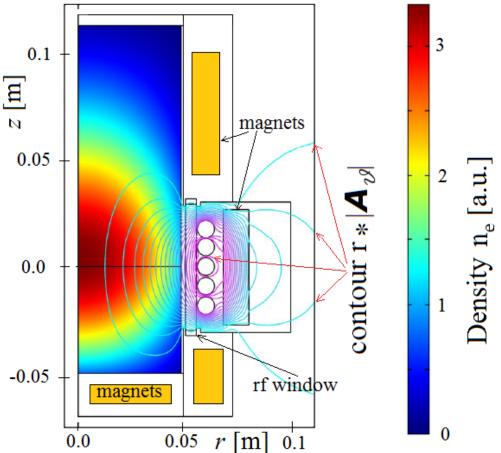
Figure 5. Major steps of numerical simulations.

5.2) Results; s_{ee}=0 case

Beware: Any correct model of ionization and rf absorption in plasma typically includes a possible instability: the more electron are produced the more rf power can be adsorbed which gives even more electrons, provided gas density ng and coil current is kept constant. Stabilization is more easily inbuilt in the model by adjusting gas density so to have a reasonable plasma density at given point (set by experience or as experimental input data)

Once model has converged, the density typically peaks on source axis, where plasma confinement is better (so more plasma accumulates)

Similarly the induction rf filter peaks on the rf coil; it is possible to define pseudo flux lines of rf magnetic field, as the contour level of $r |A_9|$; the absolute value takes care of phasor rf field and in static limit, gives the usual flux line



Plasma density ne and 'pseudo-fluxlines' of rf magnetic field (that is, level curve of $r|A_{\vartheta}|$). Note the old NIO1 design with only 5 turn coils

5.2.1) NIO1 with 7 turn coil as built

Static magnetic field is providef in NIO1 by 3 terms: a strong rear multipole; a significant field near PG, due to the fringe field of acceleraot electrodes; a filter field, with a bell shaped zprofile centered in the fron region (filter field strength B_{fa} is adjustable)

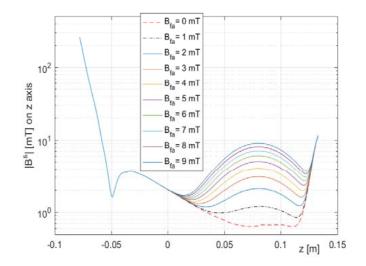
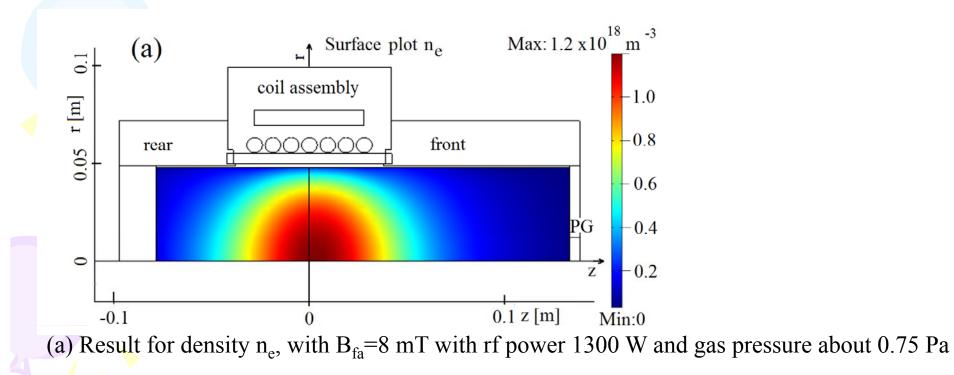
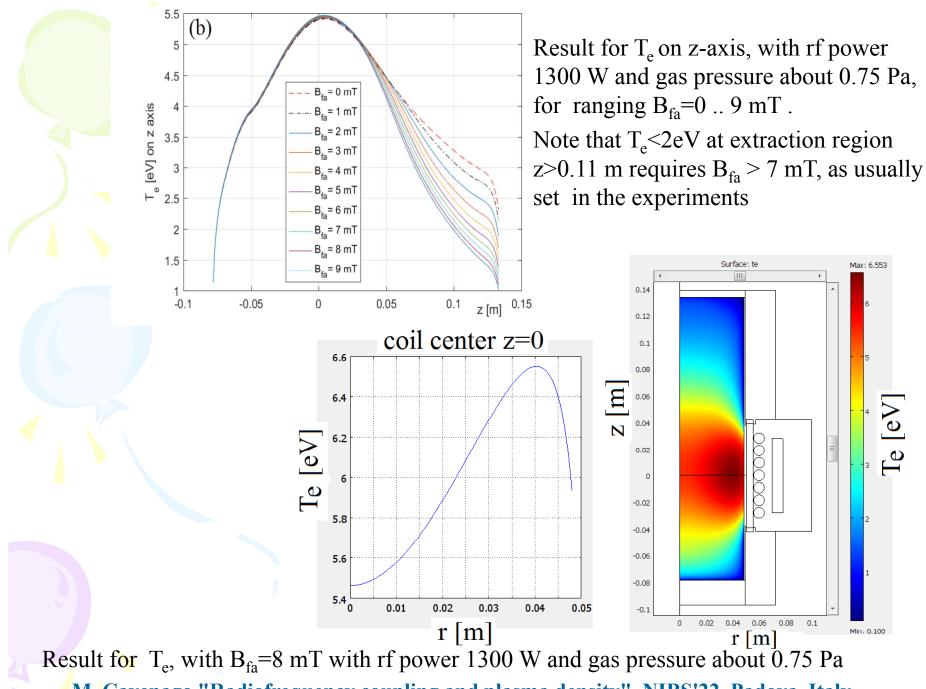


Figure 6. Total field strength, for filter strength from $B_{fa} = 0$ to 9 mT



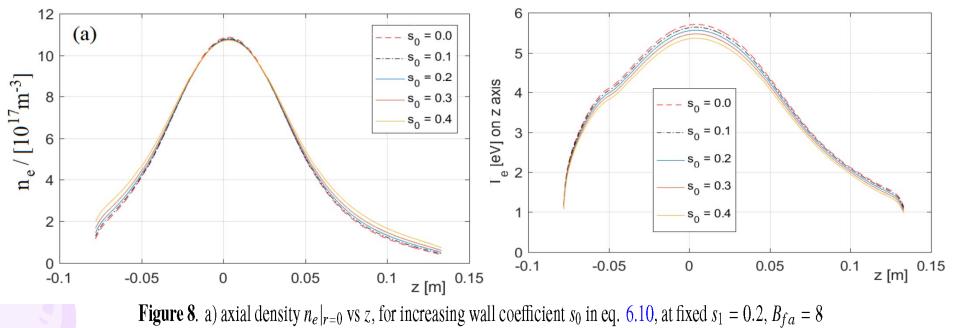


5.3) Results; s_{ee}>0 case

Here we show how plasma equilibrium depend from assumed see, for a sensitivity study (to be later rapidly compared with experiments). In principle, see can be any function of boundaries, but we restrict to three zones and parameters. On metal walls, $s_{ee}=s_0$ (with value scanned <0.4); on dielectric walls, we add a quantity s1<0.4, so that see=s0+s1. In both zones

$$s_{ee} = s_0 + s_1 \Theta_s(z_w - |z|, w)$$

where $z_w = 38$ mm from NIO1 geometry, Θ_s is a smoothed Heaviside function. Optionally, an extraction effect can be added assuming $s_{ee}=0$ at extraction, for r<r_h (11.4 mm for equal area)

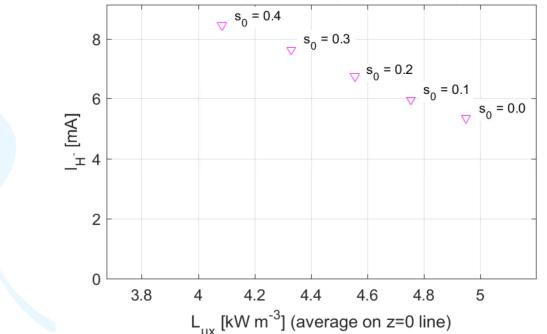


mT, $p_s \approx 0.7$ Pa and $P_s = 1300$ W; (b) axial temperature T_e for the same cases.

Note the differences in central T_e and in extraction n_e

continue 5.3) Results; s_{ee}>0 case

Finally, from known profiles of n_e and T_e , and atomic data [Johnson, 1973] a global plasma luminosity for any line of sight (in particular, for the axial line of sight of NIO1) can be calculated, and is very sensitive to central T_e . Also the extraction current in Cs-free regimes can be guessed with comparison to previous works [Pagano, 2007, Mossbach 2005) for the n_{H^-}/n_e relation. We have I_{H^-} growth with n_e and $1/T_e$ as expected More work to calculate I_{H^-} directly from n_e and T_e profile is in progress.



For previous slide cases, estimated plasma light emission L_{ux} and ion current I_{H-}

In conclusion, the model is able to predict an anit-correlation of Lux and I- (at constant source power and pressures) always observed in NIO1. In particular the gas conditioning experiment (in Cs-free regime until 2019) show that wall can be conditioned, with results as in the above figure range.

M. Cavenago "Radiofrequency coupling and plasma density", NIBS'22, Padova, Italy

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6) CONCLUSION

Induction heating involve both particle and EM field modeling. While a calculation of each electron trajectory is clearly too long especially for ion source design, a vast literature has developed useful approximation to this problem, introducing the so called stochastic heating, with several formulas here reviewed. Induction heating of plasma so reduces to typical nonlinear problem of partial differential equation (PDE), with gas ionization rate and rf power absorption in positive feedback. Stability is obtained (both in the experiment and in the modeling) by the limited amount of rf power and gas available. Relation between physical boundary condition and possible wall status (similar to known effect in ECRIS) was introduced and parameterized by a s_{ee} coefficient. The simple model solution well reproduce observed trends for gas density, equivalent plasma resistance and plasma luminosity. Most of all, solution are sensitive to s_{ee} in a way consistent with some experimental evidence from NIO1.

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THANK YOU FOR ATTENTION

(see bibliography next slides)



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